

late 10/11/2022

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SERIES: VQA3-S | **DESCRIPTION:** IGBT DRIVER DC-DC

FEATURES

- designed for IGBT driver applications
- reinforced insulation
- CMTI > 200 kV/ μ s
- ultra-low isolation capacitance: 3.5pF (typ.)
- -40 ~ 105°C temperature range
- continuous short circuit protection
- UL/cUL 62368 certified

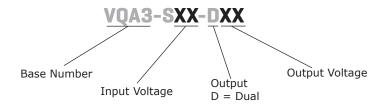




MODEL		input oltage	output voltage	output current	ripple and noise¹	efficiency
	typ (Vdc)	range (Vdc)	(Vdc)	max (mA)	max (mVp-p)	typ (%)
VQA3-S5-D15-S	5	4.5~5.5	15 -8.7	80 -40	150	82
VQA3-S12-D15-S	12	10.8~13.2	15 -9.0	100 -100	100	87
VQA3-SX12-D15-S	12	9.0~15.0	15 -9.0	100 -100	100	87
VQA3-S15-D15-S	15	13.5~16.5	15 -9.0	100 -100	100	87
VQA3-S24-D15-S	24	21.6~26.4	15 -9.0	100 -100	100	82

Notes: 1. Ripple and noise are measured at 20 MHz BW by "parallel cable" method. See application notes.

PART NUMBER KEY



INPUT

parameter	conditions/description		typ	max	units
	5 Vdc input model	-0.7		9	Vdc
surge voltage ²	12 Vdc input model	-0.7		18	Vdc
	15 Vdc input model	-0.7		21	Vdc
	24 Vdc input model	-0.7		30	Vdc
temperature coefficient	at full load		±0.04	±0.1	%/°C

Note: 2. For 1 second maximum.

OUTPUT

parameter	conditions/description		min	typ	max	units
capacitive load	5 Vdc input model all other input models				1,000 2,200	μF μF
line regulation	5 Vdc input model all other input models			1.1 1.1	1.4 1.5	% %
load regulation ³	5 Vdc input model	+Vo output -Vo output		8 10	15 15	% %
	all other input models +Vo output -Vo output			6 8	15 15	% %
switching frequency	at full load, nominal input			200		kHz

Note: 3. At 10 ~ 100% load

PROTECTIONS

parameter	conditions/description	min	typ	max	units
short circuit protection	continuous, auto-recovery				
CMTI	input to output	±200			kV/µs

SAFETY AND COMPLIANCE

parameter	conditions/description	min	min typ ma		units		
isolation voltage	voltage input to output for 1 minute, 1 mA max 5,600				Vdc		
continuous withstand voltage	input to output according to IEC 61800-5-1	1,700			V		
isolation resistance	input to output at 500 Vdc	1,000			ΜΩ		
isolation capacitance	input to output, 100 kHz/0.1 V		3.5	5	pF		
safety approvals	certified to 62368: UL/cUL designed to meet 62368: EN/IEC						
conducted emissions	CISPR32/EN55032 CLASS A, CISPR32/EN55032 (CISPR32/EN55032 CLASS A, CISPR32/EN55032 CLASS B (see recommended circuit)					
radiated emissions	CISPR32/EN55032 CLASS A, CISPR32/EN55032 (CISPR32/EN55032 CLASS A, CISPR32/EN55032 CLASS B (see recommended circuit)					
ESD	5 Vdc input models: IEC/EN 61000-4-2 Contact ±6kV, perf. Criteria B other models: IEC/EN 61000-4-2 Contact ±8kV, perf. Criteria B						
MTBF	as per MIL-HDBK-217F at 25°C	3,500,000			hours		
RoHS	yes						

ENVIRONMENTAL

parameter conditions/description		min	typ	max	units
operating temperature	see derating curve	-40		105	°C
storage temperature		-55		125	°C
storage humidity	non-condensing	5		95	%

SOLDERABILITY

parameter conditions/description		min	typ	max	units
pin soldering resistance temperature	1.5mm from case for 10 seconds			300	°C

MECHANICAL

parameter	conditions/description	min	typ	max	units
dimensions	19.50 x 9.80 x 12.5 (0.768 x 0.386 x 0.492 inch)				mm
material	plastic, flame retardant and heat resistant				
weight			4.3		g
cooling method	natural convection				

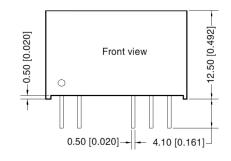
MECHANICAL DRAWING

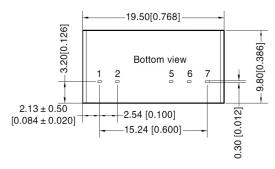
units: mm [inches]

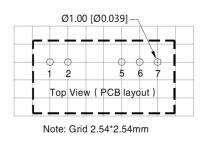
tolerance: $\pm 0.50 \ [\pm 0.020]$

pin section tolerance: ± 0.10 [± 0.004]

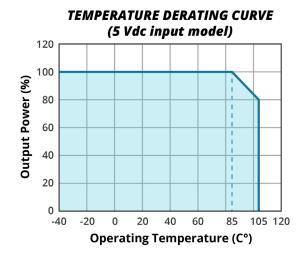
PIN CONNECTIONS				
PIN FUNCTION				
1	Vin			
2	GND			
5	-Vo			
6	0V			
7	+Vo			

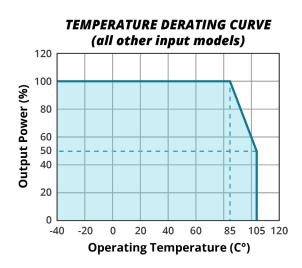




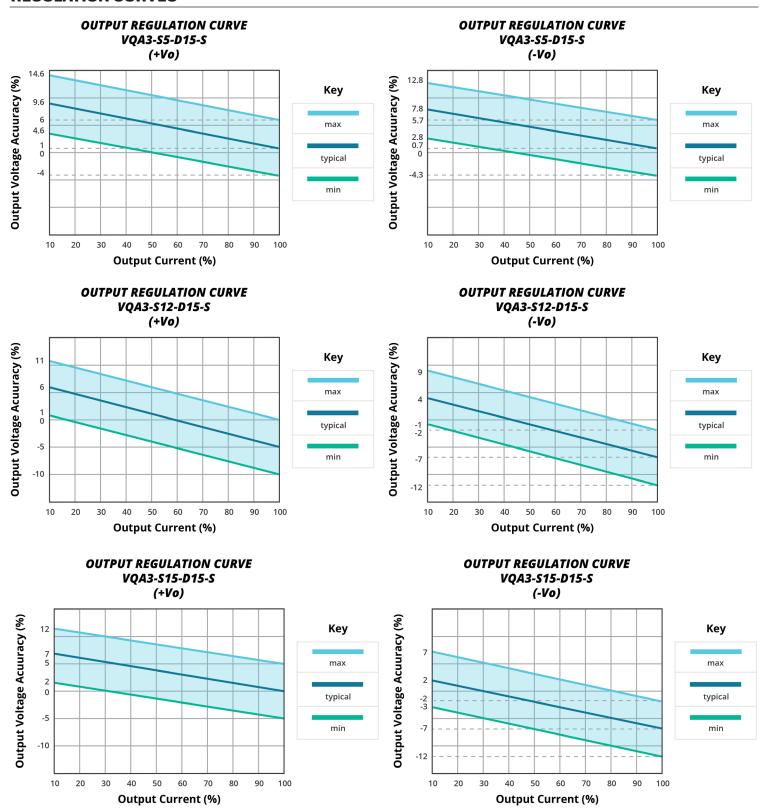


DERATING CURVES

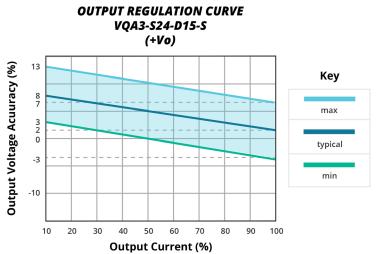


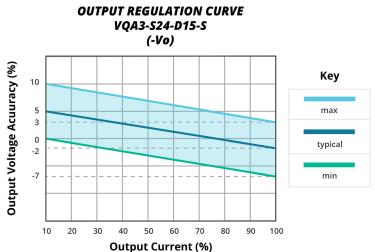


REGULATION CURVES

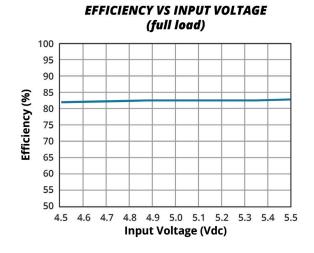


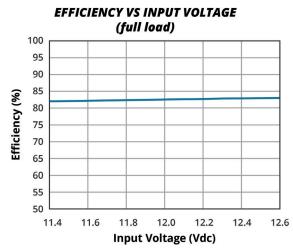
REGULATION CURVES (CONTINUED)

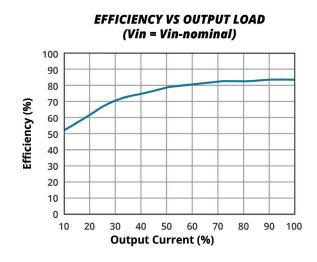


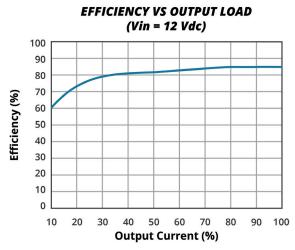


EFFICIENCY CURVES









EMC RECOMMENDED CIRCUIT

Figure 1 LDM1 Vin

Load 1 DC-DC ov C2 GND

Table 1

Project		5V	12V, 15V, 24V
	C1/C2	4.7μF/16V	1μF/50V
EMI	C3/C4	10µF/50V (low internal resistance)	100µF/30V (low internal resistance)
	LDM	6.8µH	33µH

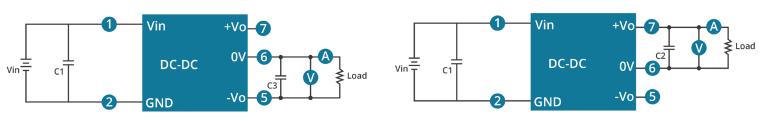
LDM1 +Vo Load 1 DC-DC ov C1 _ C2 Load 2 ||CY1

Table 2

Project		5V
	C1/C2	4.7µF/16V
EMI	C3/C4	10μF/50V (low internal resistance)
	LDM	6.8µH
	CY1	330pF

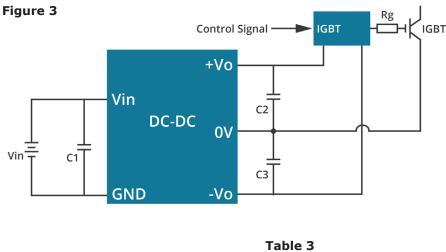
TEST CONFIGURATION

Figure 2



C1, C2, C3: 100 µF/35V (low resistance)

APPLICATION CIRCUIT



C1/C2/C3 $100\mu H/35V$ (low ESR)

Notes:

- The lead connecting the power supply module and IGBT driver must as short as possible.
 The output filtering capacitor should be connected as close as possible to the converter and the IGBT driver.
 The peak of the IGBT driver gate drive current is high, so low internal resistance electrolytic capacitor is recommended to be used for the power supply module output filter capacitor.
- 4. The maximum capacitive load is tested at nominal input voltage and full load.
- 5. Consider fixing with glue near the module if being used in vibration occasion.
- 6. All specifications are measured at Ta=25°C, humidity <75%, nominal input voltage and rated output load unless otherwise specified.

CUI Inc | SERIES: VQA3-S | DESCRIPTION: IGBT DRIVER DC-DC

REVISION HISTORY

rev.	description	date
1.0	initial release	10/11/2022

The revision history provided is for informational purposes only and is believed to be accurate.



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CUI offers a two (2) year limited warranty. Complete warranty information is listed on our website.

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